

**Patent Application**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Applicant:** Gerald Friesse

**Examiner:** Song, Matthew J.

**Serial No:** 09/893,160

**Group:** Art Unit 1765

**Filed:** June 27, 2001

**Docket:** 8055-83CIP (In1292USD1)

**For:** **POWER PADS FOR APPLICATION OF HIGH CURRENT  
PER BOND PAD IN SILICON TECHNOLOGY**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA. 22313

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**AMENDMENT**

This is a response to the Office Action mailed on March 24, 2004. Please amend the above-identified application as follows:

**CERTIFICATE OF MAILING 37 C.F.R. § 1.8(a)**

I hereby certify that this correspondence (and any document referred to as being attached or enclosed) is being deposited with the United States Postal Service as first class mail, postage paid in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on August 24, 2004.

Dated: August 24, 2004

  
Frank V. DeRosa